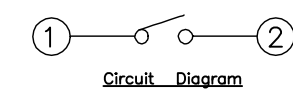
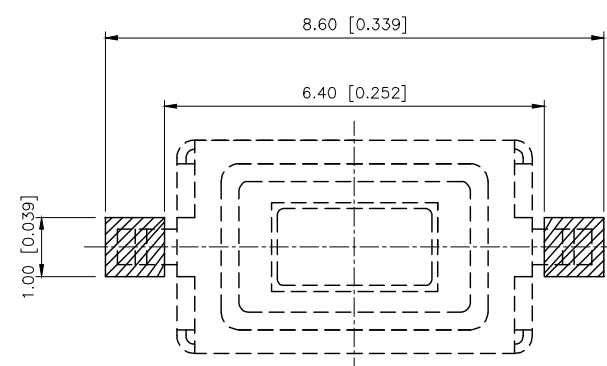
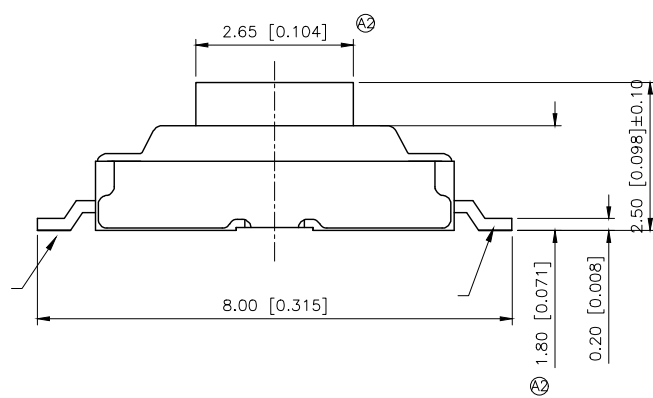
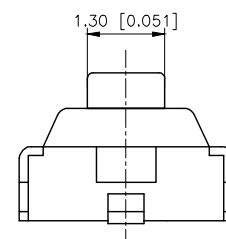
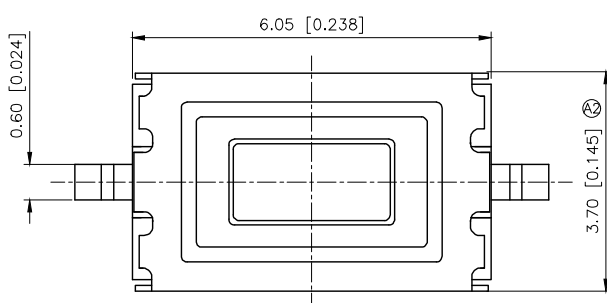


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A1	N/A			2025.06.03	
A2	ECN-P-2025121501	Ⓐ2X3		2025.12.15	



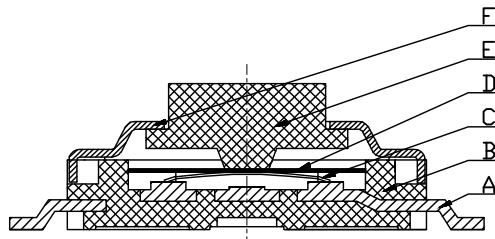
SPECIFICATION
Contact Rating 50mA,12V DC
Contact Resistance 100mΩ max
Insulation Resistance 100MΩ min.500V DC
Dielectric Strength 250V AC/1minute
Travel 0.25mm
Operating Temp -30 ~+85
Storage Temp -30 ~+80

P.C.B MOUNTING PATTERN DIMENSION
The following soldering patterns are recommended for reflow soldering



PAPT NO	TS-1101-B-W
Operating Force	A:100gf B:160gf C:260gf
Height	H:2.5
Color	R:Red W:white

F	Cover	1	SUS 0.10t	
E	Keystake	1	PPA	White
D	Dust cover film	1	Polyimide	
C	Contact	1	F.ag/SUS	
B	Base	1	PA6T	Black
A	Card	1	Brass 0.20t	Plating silvering
ITEM	PAPT NAME	QTY	MATERIAL	FINISHING



AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN		VIEW:	MODEL TYPE: TACT SWITCH
CHECKED		UNIT: mm/in	PART NO.: TS-1101-B-W
APPROVED		SIZE: A4	DWG NO.: